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5C/1085 U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

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| APPL NUM 10002544 | FILING DATE 11/21/2001 | CLASS 205 | SUBCLASS 157 | GAU 1741 | EXAMINER Leader |
| **APPLICANTS: Liu Chung-Shi; Yu Chen-Hua; | | | | | |
| **CONTINUING DATA VERIFIED: | | | | | |
| ** FOREIGN APPLICATIONS VERIFIED: | | | | | |
| PG-PUB <input type="checkbox"/> | | DO NOT PUBLISH <input type="checkbox"/> | | RESCIND <input type="checkbox"/> | |
| Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no | | 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no | | ATTORNEY DOCKET NO 67,200-535 | |
| Verified and Acknowledged Examiners's initials | | | | | |
| TITLE : Method for forming cathode contact areas for an electroplating process | | | | | |
| U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94) | | | | | |

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|--|-----------|---|-------------------------|
| NOTICE OF ALLOWANCE MAILED | | CLAIMS ALLOWED | |
| | | Total Claims <input type="checkbox"/> Print Claim for O.G. <input type="checkbox"/> | |
| ISSUE FEE | | DRAWING | |
| Amount Due | Date Paid | Sheets Drawg. | Figs. Drawg. Print Fig. |
| | | Application Examiner | |
| <input type="checkbox"/> TERMINAL DISCLAIMER | | PREPARED FOR ISSUE | |
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